



Europäisches Patentamt
European Patent Office
Office européen des brevets



(11) EP 1 061 789 A2

(12) EUROPEAN PATENT APPLICATION

(43) Date of publication:
20.12.2000 Bulletin 2000/51

(51) Int Cl.7: H05K 9/00

(21) Application number: 00305142.2

(22) Date of filing: 16.06.2000

(84) Designated Contracting States:
AT BE CH CY DE DK ES FI FR GB GR IE IT LI LU
MC NL PT SE
Designated Extension States:
AL LT LV MK RO SI

(72) Inventor: Koleda, Eugen
DK-2740 Herlev (DK)

(74) Representative: Jones, Kendra Louise
Nokia IPR Department,
Nokia House,
Summit Avenue
Farnborough, Hampshire GU14 0NG (GB)

(30) Priority: 18.06.1999 GB 9914263

(71) Applicant: NOKIA MOBILE PHONES LTD.
02150 Espoo (FI)

(54) Shielding can for a printed circuit board

(57) A shielding can for a printed circuit board comprise a frame with side walls and a lid with means to increase flexibility of the lid. The flexibility means are slits on the sides of the lid. These slits enable a flexible contraction, when soldering the shielding can onto the printed circuit board. The invention also includes a method for mounting the shielding can onto printed cir-

cuit boards. The shielding can is placed onto the printed circuit board and heated slowly to melt the solder paste to solder the shielding can to the printed circuit board. The heating phase is followed by a fast cooling phase, and the flexible means (the slits on the shielding can) reduces the internal stress, which occurs when the shielding can is exposed to different temperatures at the same time, without any permanent deformations.

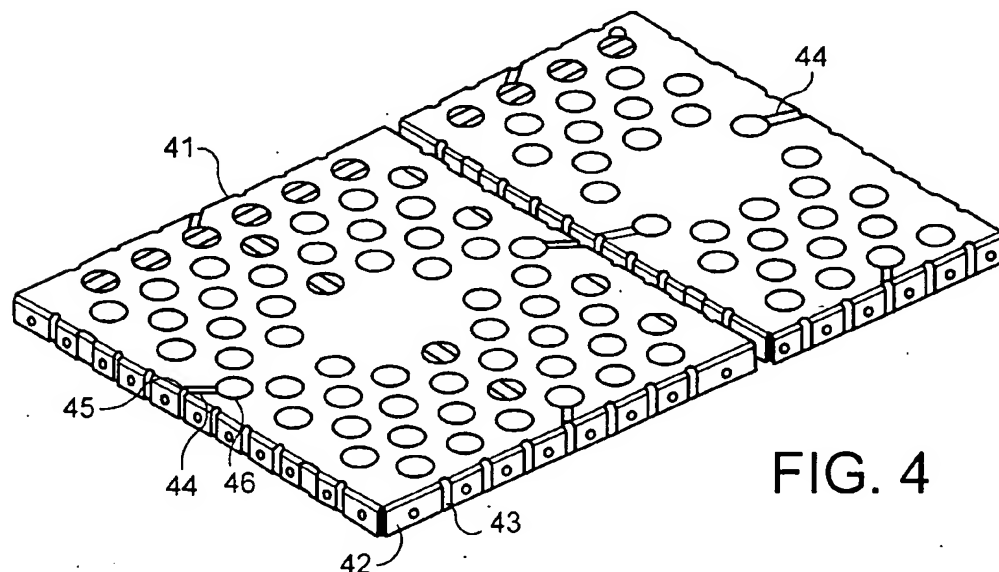


FIG. 4

EP 1 061 789 A2

Description

[0001] The invention relates to a shielding can for protecting components on a printed circuit board (PCB), preferably for a cellular phone, against interference from other components due to EMC. A shielding can is a cage that covers a number of electronic components on a printed circuit board, and thereby protects these components from disturbing other electronic components on the printed circuit board.

[0002] The use of shielding cans is well known because all GSM phones have printed circuit boards equipped with different components that disturb each other if they are not shielded from each other.

[0003] The shielding cans are usually made in at least two different embodiments. The first embodiment comprises one entire box shaped piece soldered onto the printed circuit board. This type of shielding can does not permit one to access components covered by the shielding can, which makes it very difficult to repair or inspect any of the components covered or shielded by the shielding can. Furthermore it is often required to solder the components beneath the shielding can onto the printed circuit board before soldering the shielding can, because you cannot get enough heat to the components to make a good solder joint. An alternative is having holes or apertures to let the heat in to solder the components at the same time as the shielding can. However these types of shielding cans are often made of a rather thick material so even with holes or apertures you cannot get enough heat to solder the components properly at the same time as the shielding can.

[0004] The second embodiment includes two pieces, one frame and one lid. The lid is snapped onto the frame and can be removed from the frame, which is soldered onto the printed circuit board, to enable repairing or inspection of the components shielded by the shielding can. The second embodiment may be attached to the printed circuit board in different ways. One way is to solder the frame onto the printed circuit board first and then attach the lid to the frame. Another way is snap the lid onto the frame and solder the assembly onto the printed circuit board, but then there is a need for holes or apertures in the lid to let in the heat during soldering. Otherwise the components covered or shielded by the shielding can will not be properly soldered since the heat can not reach the components. It is preferable to solder the frame with the lid attached because you save work operations. However according to prior art there are problems getting a good solder joint, when using a pre-joined shielding can.

[0005] During the soldering process the printed circuit boards are moved continuously through an oven. When the printed circuit board leaves the oven a significant temperature gradient is generated and this causes the soldering to congeal from one end towards the other end. Due to internal stress, caused because one end of the shielding can is in a hot area while the other end is

starting cooling off, in the shielding cans, they tend to start lifting in the hottest end prior to the congealing. The internal stress, causing the lifting, is a problem, when having rather thin material in the shielding can. To avoid these kinds of problems one has until now relied on: manual soldering, smaller shielding cans, thicker material in the shielding cans, a lower cooling gradient or soldering of the frame without the lid.

[0006] An object of the invention is to provide a shielding can for a printed circuit board.

[0007] This objective is obtained by a substantially rectangular shielding can, which include side walls or a frame and a lid adjacent to the side walls. The lid has means for increasing the flexibility of the lid. This flexibility is, according to the preferred embodiment, obtained by providing at least one slit that is adjacent to the sides of the lid and extending substantially transverse thereto. There ought to be at least two slits on the lid, one on each side of the lid that is exposed for a significant temperature gradient during the soldering process. There could be slits on the other sides to simplify the production of the shielding cans. Then the pick-and-place machine does not have to care about the orientation of the shielding can when placing the can on the printed circuit board.

[0008] Another object of the invention is to provide a communication terminal with a printed circuit board having shielding cans.

[0009] This is achieved through a communication terminal with a printed circuit board having shielding cans where said shielding cans are substantially rectangular and includes side walls and a lid adjacent to the side walls, where the lid has means for increasing the flexibility of the lid. The means for increasing the flexibility of the lid, according to the preferred embodiment, are slits on at least two sides of the lid, where the each slit is adjacent to the sides of the lid and extending substantially transverse thereto.

[0010] Yet another object of the invention is to provide an improved method of attaching a shielding can to a printed circuit board

[0011] This purpose is obtained by a shielding can, which comprise two parts, a frame with side walls and a lid, adjacent attached to the frame. The mounting of shielding cans is executed by e.g. a pneumatical device (pick and place machine) that places the shielding can onto a printed circuit board, which has been prepared with solder paste, in one joined piece. After that the printed circuit board is warmed to soldering the shielding can onto the printed circuit board, where the soldering temperature increases slowly to make the solder paste melt entirely. This is followed by a fast cooling phase, where the shielding can has means for increasing the flexibility of the lid, formed by slits on the sides of the lid, to adapt to the temperature changes.

[0012] With this method it is possible to handle and to mount the shielding can in one step and thereby reducing the working steps.

[0013] The invention will be explained more fully below, by way of example, in connection with preferred embodiments and with reference to the drawings, in which:

[0014] Fig. 1 schematically illustrates a preferred embodiment of a hand portable phone having a shielding can according to the invention.

[0015] Fig. 2 schematically shows the essential parts of a telephone for communication with a cellular network.

[0016] Fig. 3a-b shows a printed circuit board having a shielding can according to the invention.

[0017] Fig. 4 shows a shielding can according to the invention.

[0018] Fig. 5 shows a frame according to the invention.

[0019] Fig. 6 shows a lid according to the invention.

[0020] Fig. 7 shows an overview of the mounting process of the shielding can onto the printed circuit board.

[0021] Fig. 8 shows a printed circuit board having a shielding can according to the invention.

[0022] Fig. 1 shows a preferred embodiment of a phone according to the invention, and it will be seen that the phone, which is generally designated by 1, comprises a user interface having a keypad 2, a display 3, an on/off button 4, a speaker 5, and a microphone 6 (only openings are shown). The phone 1 according to the preferred embodiment is adapted for communication via a cellular network, e.g. a GSM network. However the invention could have been implemented in any other communication terminal having a shielding can.

[0023] According to the preferred embodiment the keypad 2 has a first group 7 of keys as alphanumeric keys, two soft keys 8, two call handling keys 9, and a navigation key 10. The present functionality of the soft keys 8 is shown in separate fields in the display 3 just above the keys 8, and the call handling keys 9 are used for establishing a call or a conference call, terminating a call or rejecting an incoming call.

[0024] Fig. 2 schematically shows the most important parts of a preferred embodiment of the phone, said parts being essential to the understanding of the invention. The preferred embodiment of the phone of the invention is adapted for use in connection with the GSM 900MHz and GSM 1800 MHz network, but, of course, the invention may also be applied in connection with other phone networks. The processor 18 controls the communication with the network via the transmitter/receiver circuit 19 and an antenna 20 that will be discussed in details below.

[0025] The microphone 6 transforms the user's speech into analog signals, the analog signals formed thereby are A/D converted in an A/D converter (not shown) before the speech is encoded in an audio part 14. The encoded speech signal is transferred to the processor 18, which i.e. supports the GSM terminal software. The processor 18 also forms the interface to the peripheral units of the apparatus, including a RAM memory 17a and a Flash ROM memory 17b, an integrated

circuit card 16 (for GSM a SIM card), the display 3 and the keypad 2 (as well as data, power supply, etc.). The audio part 14 speech-decodes the signal, which is transferred from the processor 18 to the earpiece 5 via a D/A converter (not shown).

[0026] Fig. 3a and 3b shows a printed circuit board 40 with two shielding cans 41 mounted thereon, which covers some electronic components. The printed circuit board 40 is an inner part of the phone 1 (shown in fig. 1).

[0027] Fig. 4 shows the shielding can 41 where lid 42 is joined onto the frame 43, as when the shielding can 41 is mounted onto the printed circuit board 40. It also shows the slits 44, which extends from the edge 45 of the lid 42 into holes 46. The main purpose of the holes 46 is to enable a sufficient heat distribution, when heating the printed circuit board 40 to solder the shielding can 41 and the electronic components shielded by it, onto the printed circuit board 40. The angle between the edge 45 of the lid 42 and the longitudinal direction of the slit 44 extends substantially transversal from the edge 45. Preferably the slit 44 connects an aperture 38 in the main area of the lid 42 adjacent to the edge 45 and one of the slits 39 serving to establish the connection between the lid and the frame.

[0028] Fig. 5 shows the frame 43, which consists of side walls with fastening holes 47. The fastening holes 47 are used to snap on the lid 42. As shown in fig. 6 the lid 42 has protrusions 48 on its side walls, which snaps onto the holes 47 on the frame.

[0029] Fig. 7 shows a schematic view of the mounting process of shielding can 41 onto the printed circuit board 40. A lifting device 50 attached to the shielding can at the spot 49 (shown in fig. 6) and lifts via vacuum pressure the shielding can and places it onto the printed circuit board 40. The printed circuit board 40 has been prepared with solder paste in advance. After that a conveyor device 51 takes the printed circuit board 40 through an oven 52, where it is conveyed through to heat it up to solder the shielding can 41 onto the printed circuit board 40. The soldering temperature increases slowly to make the solder paste melt entirely, and is followed by a fast cooling phase, where the shielding can 41 has means for increasing the flexibility of the lid 42, formed by slits 44 on the sides of the lid, to adapt to the temperature changes.

[0030] The invention is not limited to the above described and in the drawings shown examples of an embodiment but can be varied within the scope of the appended claims. For example, it is also possible to have other flexible means than a slit, e.g. a spring.

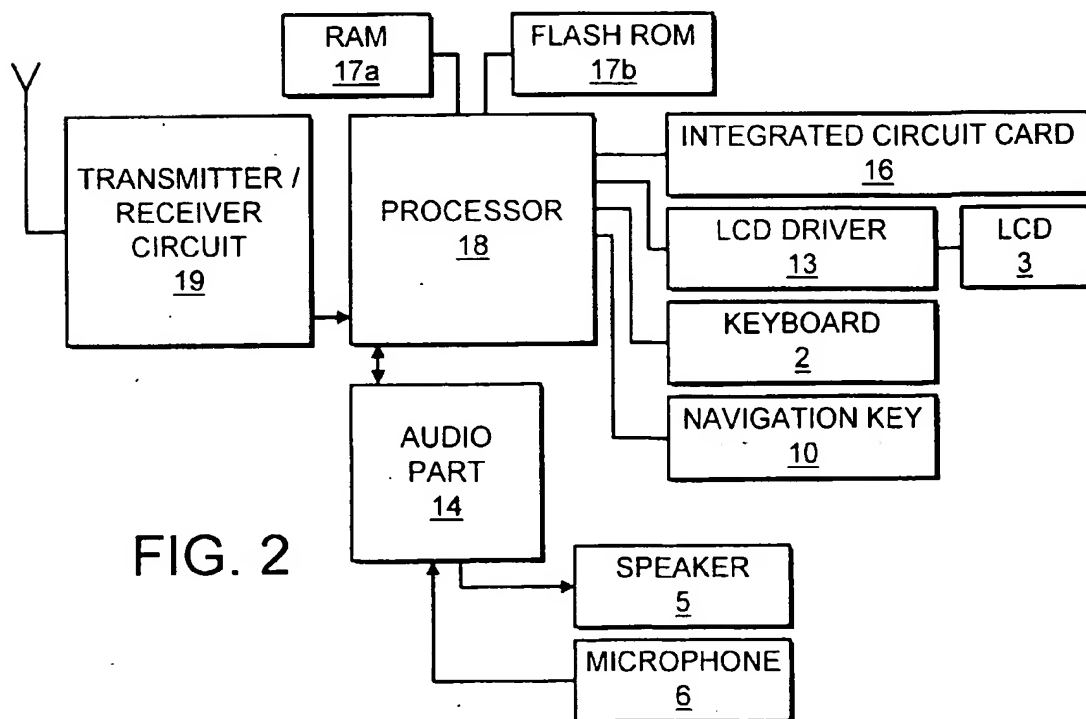
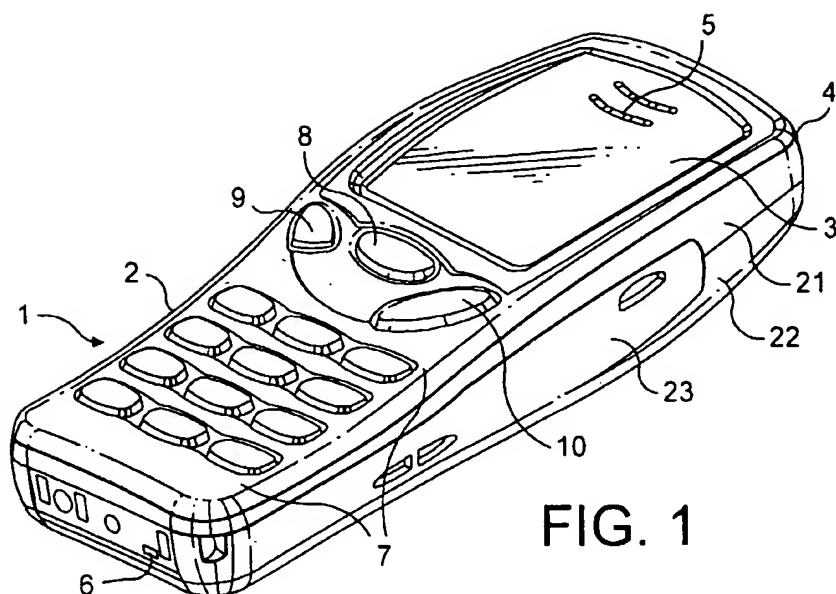
Claims

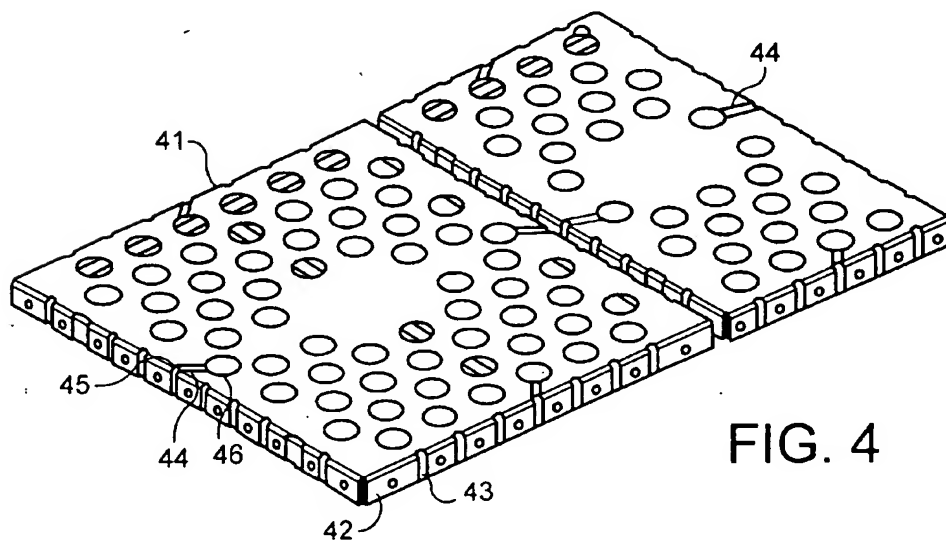
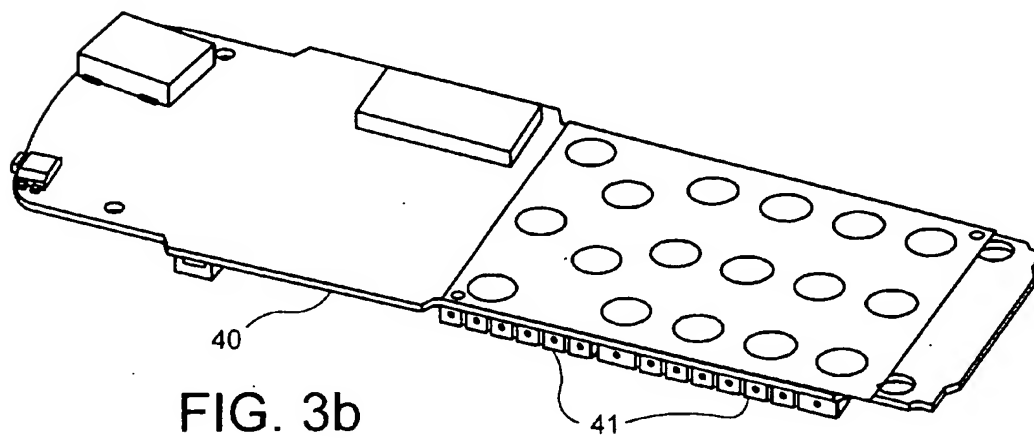
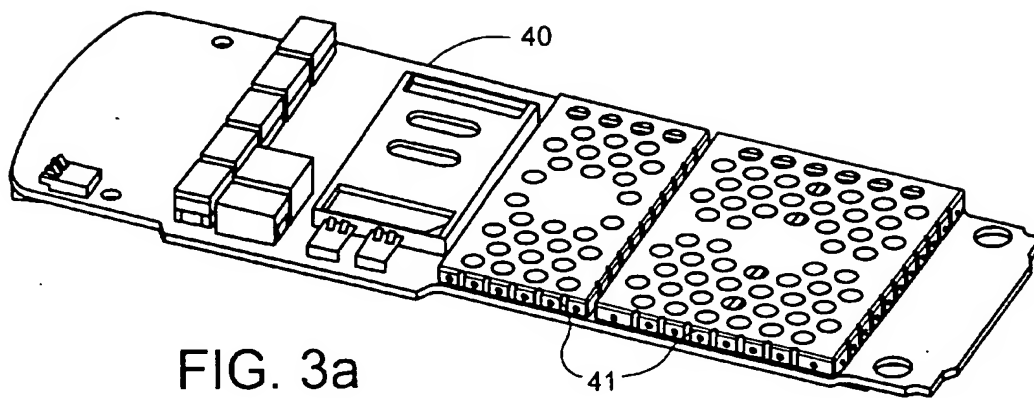
1. A shielding can for mounting on a printed circuit board, wherein the shielding can is substantially rectangular and includes side walls and a lid adjacent to the side walls, further wherein the lid has

means for increasing the flexibility of the lid.

the lid, to adapt to the temperature changes.

2. A shielding can according to claim 1 wherein the means for increasing the flexibility of the lid is by way of slits on at least two sides of the lid. 5
3. A shielding can according to claim 2, wherein the slits are adjacent to the sides of the lid and extend substantially transverse thereto. 10
4. A shielding can according to claim 2, wherein the slits are positioned to extend substantially transverse to the moving direction of the printed circuit board during soldering. 15
5. A shielding can for mounting on a printed circuit board, wherein said shielding can is substantially rectangular and includes side walls and a lid adjacent to the side walls, further wherein the lid has means for increasing the flexibility of the lid, wherein said flexibility is accomplished through slits on at least two sides of the lid, and said slits are adjacent to the sides of the lid extending substantially transverse thereto. 20
6. A communications terminal with a printed circuit board having at least one shielding can wherein said at least one shielding can is substantially rectangular and includes side walls and a lid adjacent to the side walls, further wherein said lid includes means for increasing the flexibility of said lid. 25
7. A communications terminal according to claim 6, wherein the means for increasing the flexibility of the lid are slits on at least two sides of the lid. 30
8. A communications terminal according to claim 7, wherein the slits are adjacent to the sides of the lid and extending substantially transverse thereto. 35
9. A communications terminal according to claim 8, wherein the lid has means for increasing the flexibility of the lid, said flexibility being accomplished through slits placed on at least two sides of the lid adjacent to the sides of the lid and extending substantially transverse thereto. 40
10. A method for mounting shielding cans consisting of a frame and a lid on a printed circuit board, wherein onto the printed circuit board, which has been prepared with solder paste, the shielding can is placed in one joined piece, where after the printed circuit board is warmed to solder the shielding can onto the printed circuit board, where the soldering temperature increases slowly to make the solder paste melt entirely followed by a fast cooling phase, where said shielding can has means for increasing the flexibility of the lid, formed by slits on the sides of 45





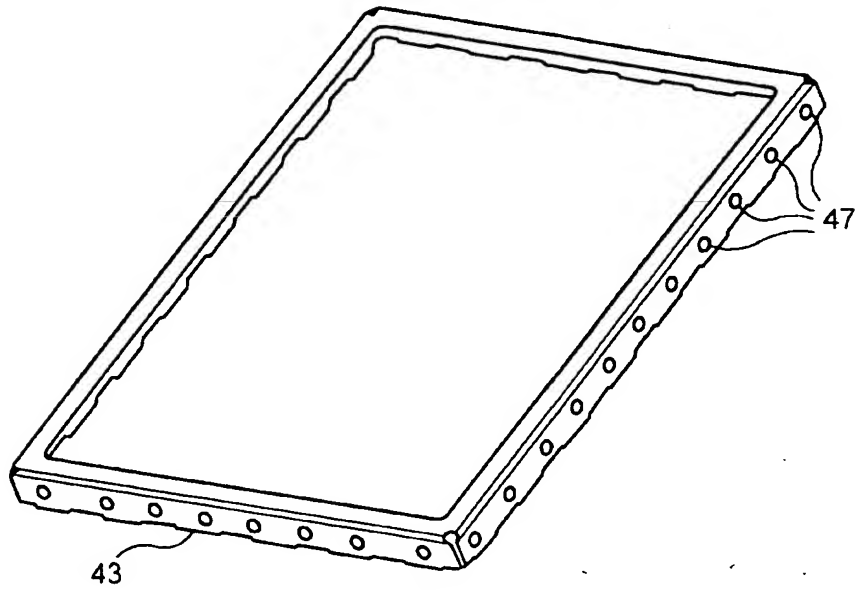


FIG. 5

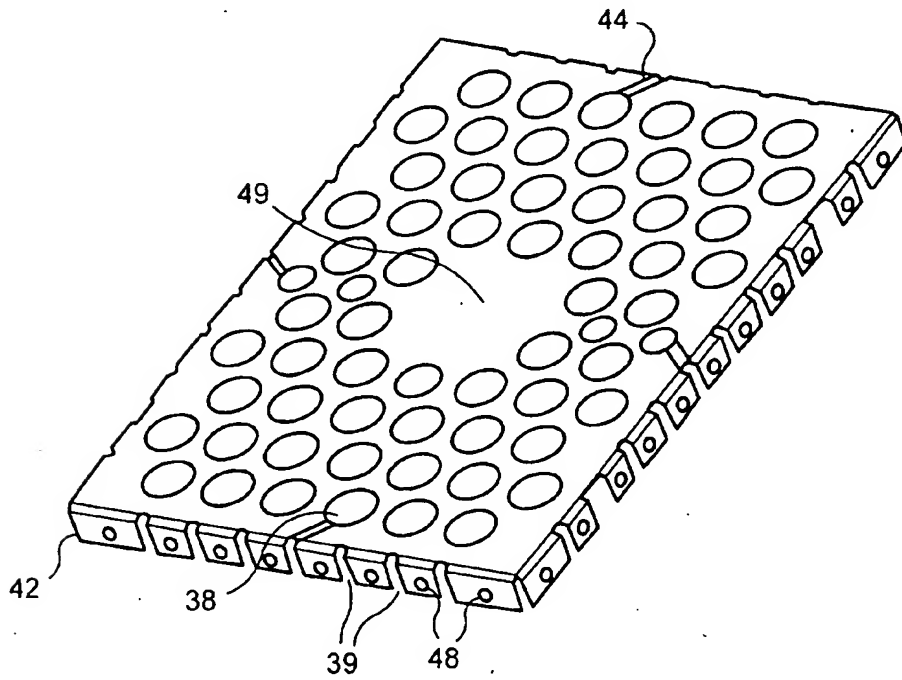


FIG. 6

